TOSHIBA Intelligent Power Device Silicon Monolithic Power MOS IC

# TPD1037BS

Low-Side Switch for Motor, Solenoid and Lamp Drive

TPD1037BS is a monolithic power IC for low-side switch. The IC has a vertical MOSFET output which can be directly driven from a CMOS or TTL logic circuit (e.g., an MPU). The IC offers intelligent self-protection functions.

#### Features

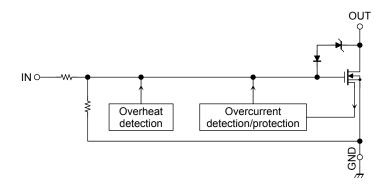
- A monolithic power IC with a new structure combining a control block and a vertical power MOSFET ( $\pi$ -MOS) on a single chip.
- Can directly drive a power load from a CMOS or TTL logic.
- Built-in protection circuits against overvoltage, overheat, and overcurrent.
- Low ON-resistance. RDS (ON) =  $0.25 \Omega$  (max) (@VIN = 5 V, T<sub>j</sub> =  $25^{\circ}$ C)
- Package TO-92 (MOD) can be packed in tape.

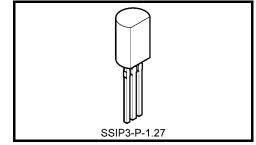
#### **Pin Assignment**



Note: That because of its MOS structure, this product is sensitive to static electricity.

#### **Block Diagram**



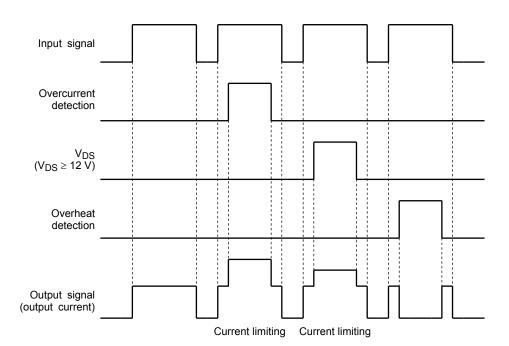


Weight: 0.36 g (typ.)

#### **Pin Description**

Pin No.	Symbol	Pin Description
1	IN	Input pin. This pin is connected to a pull-down resistor internally, so that even when input wiring is open-circuited, output can never be turned on inadvertently.
2	OUT	Output pin. If an inrush current flows (e.g., from a lamp), the current is clamped at 10 A (typ.) by an overcurrent protective circuit. Also, a 150 $\mu$ s (typ.) mask circuit is included internally, so that if V <sub>DS</sub> $\ge$ 12 V (typ.) after this mask time, the current is clamped at 3 A (typ.)
3	GND	Ground pin.

#### **Timing Chart**



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#### **Truth Table**

IN	V <sub>OUT</sub>	Mode		
L	Н	Normal		
Н	L	Norma		
L	Н	Overcurrent		
Н	L	(during inrush)		
L	Н	Overcurrent		
Н	L	(shorted load)		
L	Н	Overheat		
Н	Н	Overneat		

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Drain-source voltage	V <sub>DS (DC)</sub>	40	V	
Output current	I <sub>D</sub>	1.5	А	
Input voltage	V <sub>IN</sub>	–0.5 to 6	V	
Power dissipation (Ta = $25^{\circ}$ C)	PD	0.9	W	
Energy tolerance	ES/B	200	mJ	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Junction temperature	Tj	150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Electrical Characteristics ( $T_j = 25^{\circ}C$ )

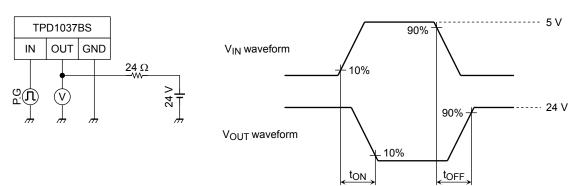
Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Drain-source breakdown voltage	V (BR) DSS	—	V <sub>IN</sub> = 0 V, I <sub>D</sub> = 10 mA	40	_	_	V
High level input voltage	VIH	—	$V_{DS} = 10$ to 40 V, $I_D = 1$ A	3.5	5	6	V
Low level input voltage	V <sub>IL</sub>	—	$V_{DS} = 10$ to 40 V, $I_D = 10 \ \mu A$	_	_	0.8	V
	I <sub>DSS (1)</sub>	-l ŀ	$V_{IN} = 0 V, V_{DS} = 40 V$	_	_	100	μА
Current at output OFF	I <sub>DSS (2)</sub>		$V_{IN} = 0 V, V_{DS} = 24 V$	_	_	10	
Input current	I <sub>IN</sub>	—	$V_{IN} = 5 V$ , at normal operation	_	_	300	μA
ON-resistance	R <sub>DS (ON)</sub>		V <sub>IN</sub> = 5 V, I <sub>D</sub> = 1 A	_		0.25	Ω
Overheat protection	Τ <sub>S</sub>	_	$V_{IN} = 5 V$		160		°C
	I <sub>S (1)</sub>		$V_{DS} = 24 \text{ V}, V_{IN} = 5 \text{ V}, \text{ during inrush}$	_	10		A
Overcurrent protection	I <sub>S (2)</sub>		$V_{DS} = 24 \text{ V}, V_{IN} = 5 \text{ V},$ when shorted load	_	3	_	
Shorted load detection voltage	V <sub>DS</sub>	_	when shorted load		12		V
Cuvitabing time	t <sub>ON</sub>	ton 1	$V_{DS}$ = 24 V, $V_{IN}$ = 5 V, $R_L$ = 24 $\Omega$		70		μs
Switching time	tOFF				120		
Diode forward voltage between drain and source	V <sub>DSF</sub>		I <sub>F</sub> = 1.5 A		0.9	1.8	V

#### **Test Circuit 1**

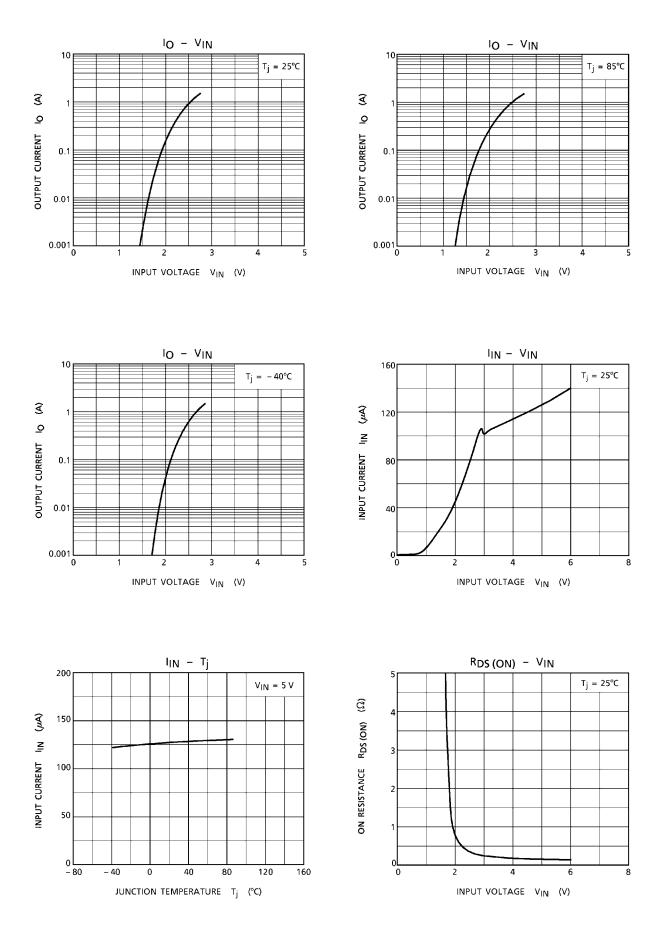
#### Switching Time Measuring Circuit

Test Circuit

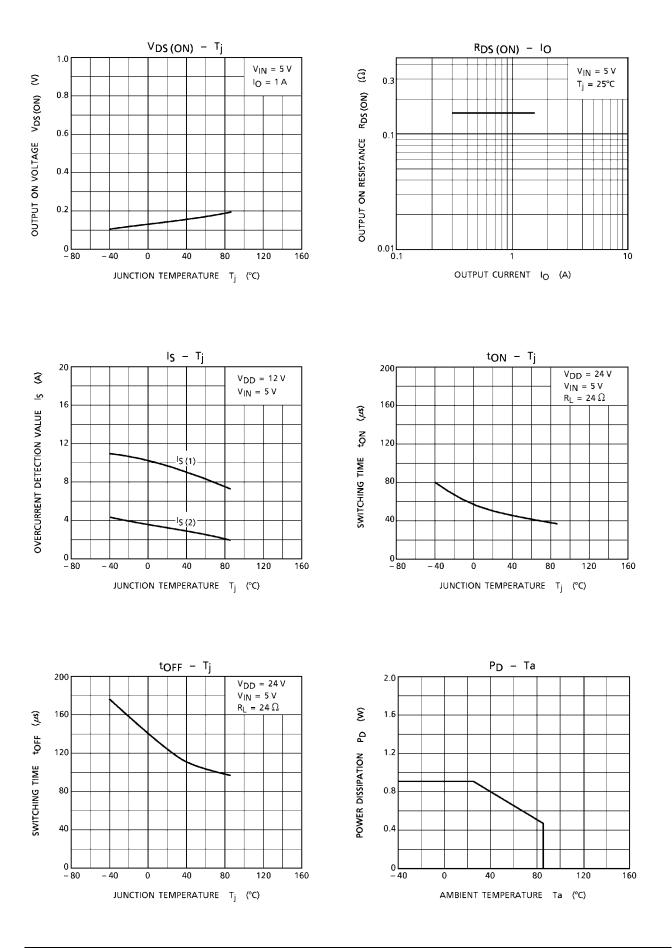
#### **Measured Waveforms**



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#### Package Dimensions

SSIP3-P-1.27

5.1мах 8.2MAX 0.75мах [•][•] 1.0MAX 0.80MAX 1.0 2.2MAX 0.60MAX 10.5MIN 1.27 1.27 2.54 **0.6MAX** 4.1 MAX 中中中

Weight: 0.36 g (typ.)

#### Unit : mm

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